

SPECIFICATION FOR LCD MODULE

Customer	:_	
CustomerP/	N _	
Model No.	:_	ESHX028-30MB-A1
Version	:_	V00
Date	:_	2022-05-
23		

Final Approval by Customer			
LCM Machinery OK		Checked By	
LCM Display OK		Checked By	

LCM NG \Box LCM OK		Approved By
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Confirmed :

DESIGN	CHECK	APPROVAL



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1[•] REVISION HISTORY

Version	Date	Description	Revised By
V00	2022-05-23	First Issued	FLQ



2[•]GENERAL INFORMATION

Item	Specification	Unit
LCD size 液晶面板尺寸	2.76	inch
Display Mode 显示模式	Normally Black	
Resolution 分辨率	480(RGB)x480	Pixel
Pixel pitch 像素尺寸	0.1497(H) x 0.1462(V)	mm
Pixel Arrangement 像素排列	RGB Vertical Stripe	
Viewing direction 视角	Free	-
Module outline dimension	73.03 (H)*76.48 (V)*2.3(D)	mm
LCD AA 液晶显示区域	70.128 (H)* 70.128 (V)	mm
TP VA 触摸可视区域	1	mm
Colors 颜色深度	16.7M	-
Driver IC 驱动芯片	ST7701SN	-
Interface 接口类型	MIPI	
Backlight 背光类型	White LED	
Touch IC 触摸芯片	1	
Surface hardness 表面硬度	1	
支持点数	1	
Touch structure 触摸结构	1	
Cover lens 盖板	1	
Colors 颜色	1	
Operating Temperature 工作温度	-20°C∼ +60° C	
Storage Temperature 存储温度	-30°C∼ +80° C	



3 ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Min	Мах	Unit	Note
Power Supply voltage 1	VCI~GND	-0.3	+4.6	V	
Power Supply voltage 2	IOVCC~GND	-0.3	+4.6	V	
Logic Input Voltage Range	V _{IN}	-0.3	IOVCC+0.5	V	
Logic Output Voltage Range	Vo	-0.3	IOVCC+0.5	V	
Operating temperature	Topr	-20	+60	°C	
Storage temperature	Tstg	-30	+80	°C	

* The absolute maximum rating values of this product are not allowed to be exceeded at any times. Should a module be used with any of the absolute maximum ratings exceeded, the characteristics of the module may not be recovered, or in an extreme case, the module may be permanently destroyed.

4 DC ELECTRICAL CHARACTERISTICS

4.1 Driving TFT LCD Panel

		AG	ND = (GND = 0V, Ta	= 25℃
Parameter	Symbol	Min	Тур	Мах	Unit
Supply voltage for analog circuit	VCI	2.5	2.8	3.6	V
Supply voltage for logic circuit	IOVCC	1.65	1.8	3.3	V
Input voltage 'H'level	V _{IH}	0.7*IOVCC	_	IOVCC	V
Input voltage 'L'level	V _{IL}	GND	_	0.3*IOVCC	V
Output voltage 'H'level	V _{OH}	0.8*IOVCC	_	IOVCC	V
Output voltage 'L'level	V _{OL}	GND	—	0.2*IOVCC	V

4.2 Backlight Characteristics

					-	Ta = 25°
ltem	Symbol	Min	Тур	Max	Unit	Condition
Forward voltage	Vf	-	6.6	-	V	lf=80
Luminance	LV		7000		cd/m ²	mA
Number of LED	-		1X4		Piece	-
Connection mode	S/P		1Serial/4P	arallel	-	-

Using condition: constant current driving method If= 4×20mA (+/-10%)

5



5 TIMING CHARACTERISTICS

5.1 High speed data transmission

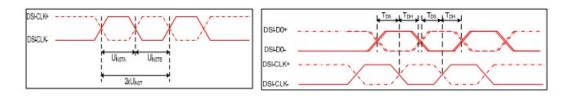


Figure 5.1.1 clock channel timing

			VDDI	=1.8,VDD=	2.8, AGND=	DGND=0V, Ta=25
Signal	Symbol	Parameter	MIN	MAX	Unit	Description
DSI-CLK+/-	2xUI _{INSTA}	Double UI instantaneous	4	25	ns	
DSI-CLK+/-	UI _{INSTA} UI _{INSTB}	UI instantaneous halfs	2	12.5	ns	UI = UI _{INSTA} = UI _{INSTB}
DSI-Dn+/-	tDS	Data to clock setup time	0.15		UI	
DSI-Dn+/-	tDH	Data to clock hold time	0.15		UI	

Figure 5.1.2 High speed mode timing Characteristics

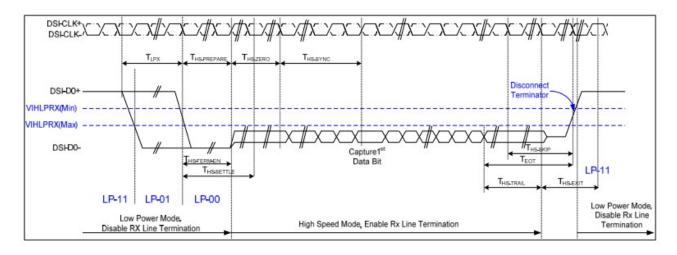


Figure 5.1.3 High speed data transmission timing sequence



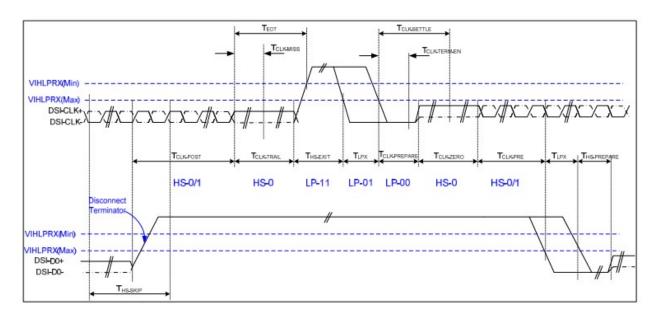


Figure 5.1.4 Switching the Clock Lane between Clock Transmission and LP Mode

5.2 Lowe Power Mode

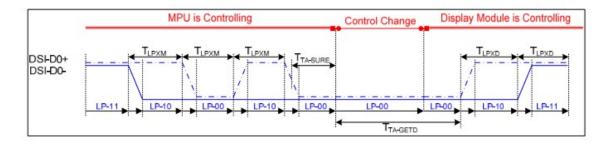


Figure 5.2.1 Bus Turnaround (BTA) from display module to MPU Timing

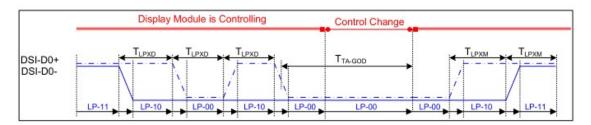


Table 5.2 .2 Bus Turnaround (BTA) from MPU to display module Timing



DSI-Dn+/-	TLPX	Length of any low power state period	50	143	ns	Input
DSI-Dn+/-	THS-PREPARE	Time to drive LP-00 to prepare for HS transmission	40+4 UI	85+6 UI	ns	Input
DSI-Dn+/-	THS-TERM-EN	Time to enable data receiver line termination measured from when Dn crosses VILMAX	-	35+4 UI	ns	Input
DSI-Dn+/-	THS-PREPARE + THS-ZERO	THS-PREPARE + time to drive HS-0 before the sync sequence	140+ 10UI	-	ns	Input

Table 5.2.3 Mipi Interface Low Power Mode Timing Characteristics

5.3 VCI (VDD) IOVCC(VDDI) off/on power sequence

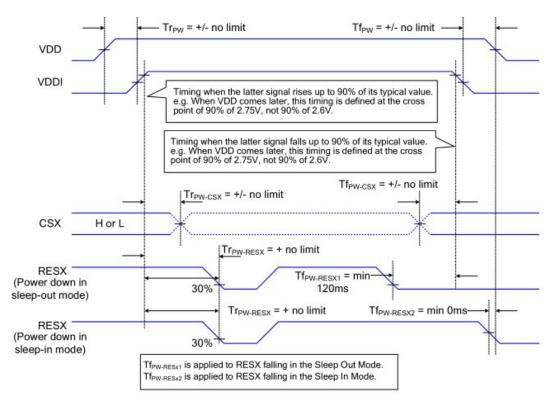
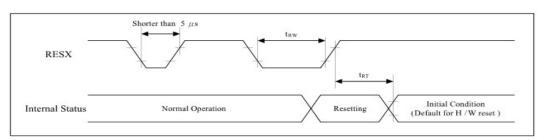


Figure 5.3.1 VCI/VDDI input power off/on sequence



6. Reset Timing



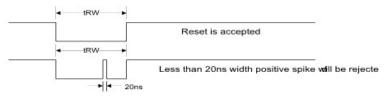
Signal	Symbol	Parameter	Min.	Max.	Unit
RESX	t _{RW}	Reset pulse duration	10(Note)		us
	t _{RT}	Reset cancel		10(Note)	ms
				120(Note)	ms

Notes:

- 1. The reset cancel also includes required time for loading ID bytes, VCOM setting and other settings from EEPROM (or similar device) to registers.
- This loading is done every time when there is HW reset cancel time (tRT) within 10 ms after a rising edge of RESX.
- 2. Spike due to an electrostatic discharge on RESX line does not cause irregular system reset according to the table below :

RESX Pulse	Action		
Shorter than 5us	Reset Rejected		
Longer than 9us	Reset		
Between 5us and 9us	Reset starts		

- 3. During the Resetting period, the display will be blanked(The display is entering blanking sequence, which maximum time is 120 ms, when Reset
- Starts at Sleep-Out status. The display remains the blank state in Sleep-In mode). Then return to Default condition for Hardware Reset
- 4. Spike Rejection also applies during a valid reset pulse as shown below :

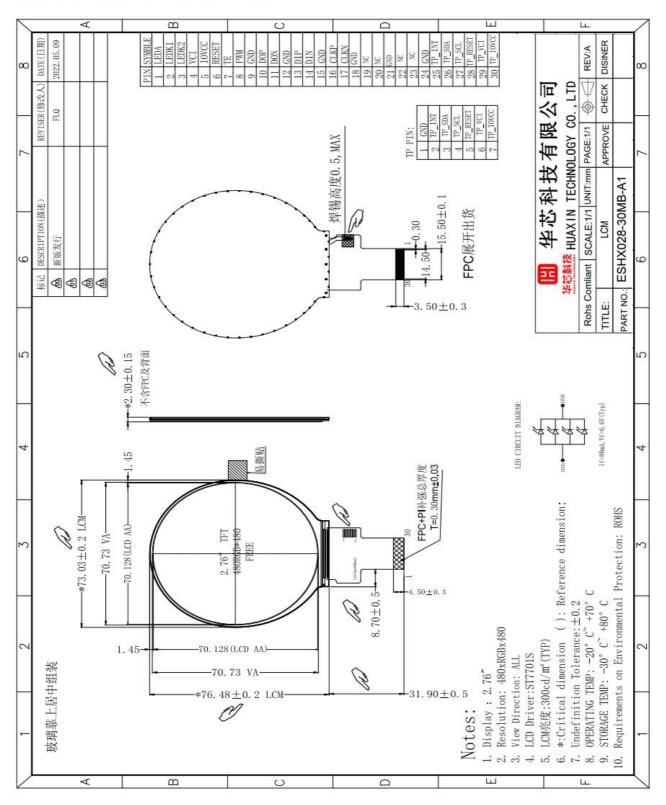


- 5. When Reset applied during Sleep-In Mode.
- 6. When Reset applied during Sleep-Out Mode

7. It is necessary to wait 10ms after releasing RESX before sending commands. Also Sleep Out command cannot be sent for 120 ms.



7 EXTERNAL DIMENSIONS





8 INTERFACE SIGNAL

Pin No.	Symbol	Description
1	LEDA	LED backlight anode
2	LEDK	LED backlight cathode
3	LEDK	LED backlight cathode
4	VCI	Power supply for the analog power
5	IOVCC	Power supply for the logic power and I/O circuit
6	RST	Reset signal(low active)
7	TE	Tearing effect output
8	PWM	The PWM frequency output for LCD driver control.
9	GND	Power ground
10	TDP0	MIPI-DSI data lane 0 negtive input pin
11	TDN0	MIPI-DSI data lane 0 posivtve input pin
12	GND	Power ground
13	TDP1	MIPI-DSI data lane 1 posivtve input pin
14	TDN1	MIPI-DSI data lane 1 negtive input pin
15	GND	Power ground
16	TCP	MIPI-DSI data lane posivtve input pin
17	TCN	MIPI-DSI data lane negtive input pin
18	GND	Power ground
19	NC	NC
20	NC	NC
21	GND	Power ground
22	NC	NC
23	NC	NC
24	GND	Power ground
25	TP_INT	INT pin for CTP
26	TP_SDA	SDA pin for CTP
27	TP_SCL	SCL pin for CTP
28	TP_RESET	Reset pin for TP
29	TP_VCI	VCI pin for CTP
30	TP_IOVCC	IOVCC pin for CTP

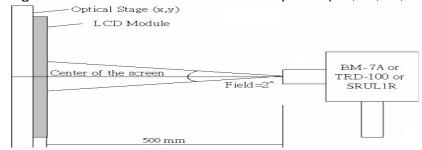


9 ELECTRO-OPTICAL CHARACTERISTICS

ltem		S	ymbol	Condition	Min	Тур	Мах	Unit	Note
Transmittance (w/o polarizer)		Т%			-	4.6	-	%	1
Contrast ratio		Cr		θ=0°	1000	1200	-	-	3
Response	time	То	n+Toff	Ta=25 ℃	-	35	40	ms	4
Surface Lurr	ninance		LV			300	-	cd/m ²	2
			Θ _{x+}		-	85	-	deg	5
		H or	Θ _{x-}	Center CR>10	-	85	-	deg	
Viewing angl	e range	V er	Θ _{Y+}		-	85	-	deg	
			Θ _{Υ-}		-	85	-	deg	
	Ded		х		0.63	0.65	0.67	-	
	Red		у		0.30	0.32	0.34	-	
	Creen		Х	Viewing	0.26	0.28	0.30	-	
CIE(x,y)	Green	Green		normal	0.56	0.58	0.60	-	
chromaticity	Dhua		х	angle Θx=θy=0°	0.12	0.14	0.16	-	6
	Blue -		у	Ta=25 ℃	0.07	0.09	0.11	-	
	\\/bitc		х		0.25	0.28	0.31	-	
	White		у		0.26	0.29	0.32	-	

Note 1.Ambient condition: 25°C±2°C, 60±10%RH, under 10 Lunx in the darkroom. Note 2.Measure device: BM-7A (TOPCON), viewing cone=2°

Lv = Average Surface Luminance with all white pixels (P1,P2,P3,P4,P5)



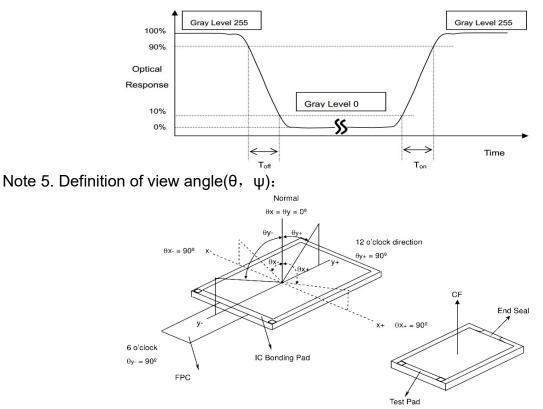
Note 3. Definition of Contrast Ratio:

CR = Average Surface Luminance with all black pixels (P1,P2,P3,P4,P5)

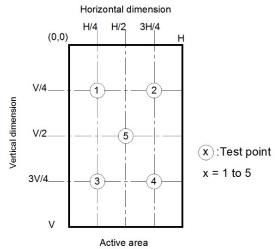


Average Surface Luminance with all white pixels (P1,P2,P3,P4,P5)

Note 4. Definition of Response Time (Ton, Toff), The response time is defined as the time interval between the 10% and 90% amplitudes.



Note 6. The LCD module should be stabilized at a given temperature for 20 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting Backlight for 20 minutes in a windless room. Measouring method for Contrast ratio, surface luminance, Luminance uniformity,CIE(x,y) chromaticity.



Light spot size Ø=7mm, 500mm distance from the LCD surface to detector lens measurement instrument is TOPCON's luminance meter BM-7



10 RELIABILITY TEST

Reliability test conditions (Polarizer characteristics null)

No.	Items	Condition	Inspection after test
1	High Temperature Storage	T = 80℃ for 48 hr	
2	Low Temperature Storage	T = -30℃ for 48 hr	
3	High Temperature Operating	T = 60℃ for 48 hr	Inspection after 4 hours
4	Low Temperature Operating	T = -20° C for 48 hr (But no condensation of dew)	storage at room temperature, the
5	High Temp. and High Humidity	T = 60° C /90% for 48 hr (But no condensation dew)	sample shall be free from defects: 1.Air bubble in the LCD
6	Thermal Shock	-20°C~25°C~70°C×5cycles (30min.) (5min.) (30min.)	2.Sealleak; 3.Non-display;
7	Dropping test (non-operation)	Drop to the ground from 76cm height, one time, every side of carton. (Packing condition)	4.missing segments; 5.Glass crack; 6.Current Idd is twice higher than initial
8	Packing Vibration (non-operation)	Frequency: 10Hz~55Hz~10Hz Amplitude: 1.0mm, X, Y, Z direction for total 3hours (Packing condition)	value.
9	ESD	Voltage:±6KV R: 330Ω C: 150pF Air discharge, 10time	

Note:

(1)The test samples should be applied to only one test item.

(2)Sample size for each test item is 5~10pcs.

(3)In case of malfunction defect caused by ESD damage, if it would be recovered to normal state after resetting, it would be judge as a good part.

Using ionizer(an antistatic blower) is recommended at working area in order to reduce electro-static voltage.

When removing protection film from LCM panel, peel off the tag slowly (recommended more than one second) while blowing with ionizer toward the peeling face to minimize ESD which may damage electrical circuit.

(4) Please use automatic switch testing mode when test operating mode.



11 inspection criterion

This specification is made to be used as the standard acceptance/rejection criteria for Normal LCM Product.

1 Sample plan

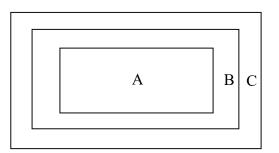
Sampling plan according to GB/T2828.1-2003/ISO 2859-1: 1999 and ANSI/ASQC Z1.4-1993,normal level 2 and based on:

Major defect: AQL 0.65 Minor defect: AQL 1.0

2. Inspection condition

Viewing distance for cosmetic inspection is about 30cm with bare eyes, and under an environment of 20~40W light intensity, all directions for inspecting the sample should be within 45° against perpendicular line. (Normal temperature 20~25°C and normal humidity 60±15%RH).

3. Definition of inspection zone in LCD.



Zone A: character/Digit area

Zone B: viewing area except Zone A (Zone A + Zone B=minimum Viewing area)

Zone C: Outside viewing area (invisible area after assembly in customer's product)

Fig.1 Inspection zones in an LCD.

Note: As a general rule, visual defects in Zone C are permissible, when it is no trouble for quality and assembly of customer's product.

4. Standards of inspection items

4.1 Major Defect	
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Item No	Items to be inspected	Inspection Standard	Classification of defects
4.1.1	All functional defects	1.No display	Major
		2.Display abnormally	
		3.Missing vertical, horizontal segment	
		4.Short circuit	
		5. Back-light no lighting, flickering and abnormal lighting.	



4.1.2	Missing	Missing component	
4.1.3	Outline dimension	Overall outline dimension beyond the drawing is not allowed.	
4.1.4	linearity	No more than 1.5%	

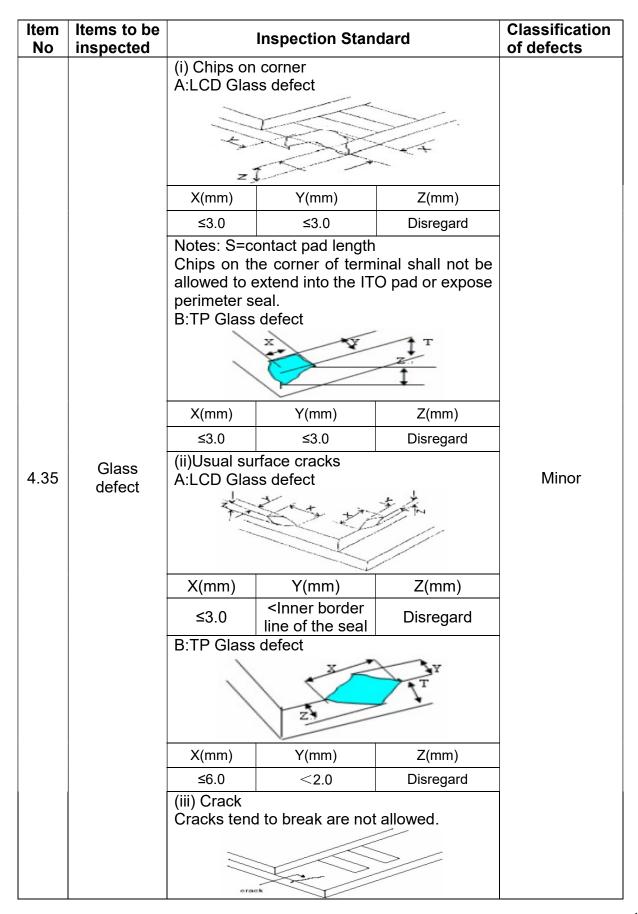
4.2 Cosmetic Defect

ltem No	Items to be inspected	Inspection Standard				Classification of defects
	Clear	For dark/white s defined as $\Phi = (x)$				
	Spots Black and white Spot defect	1 Zone Acceptable C			Qty	
	Pinhole,	Size(mm)	А	В	С	Minor
	Foreign Particle,	Ф≤0.15	lgn	ore		
	polarizer	0.15<Ф≤0.20		2	lanara	
	Dirt	0.20<Ф≤0.30		1	- Ignore	
		Φ>0.30	(C		
		2				
		Zone	Acceptable Qty		Qty	
4.2.1	Clear	Size(mm)	А	В	С	
	Spots TP Dirt	Ф≤0.15	Ignore		Minor - Ignore	Minor
		0.15<Ф≤0.20	2			
		0.20<Ф≤0.30		1	gnore	
		Φ>0.30	0			
		3			·	
	Dim Spots	Zone	Acceptable Qty		Qty	
	Circle	Size(mm)	А	В	С	
	shaped and dim	Ф≤0.2	lgn	ore		Minor
	edged defects	0.20<Ф≤0.40		2	laporo	
		0.40<Ф≤0.60		1	- Ignore	
		Φ>0.60	(C		



ltem No	Items to be inspected		Classification of defects			
	Line	Size(mm)		Acceptable Qty		
	defect	L(Length)	W(Width)	Z	one	
	Black line, White line,	E(Eoligai)	W(Widail)	A B	С	
	Foreign	Ignore	W≤0.05	Ignore		Minor
	material	L ≤5.0	0.05 <w≤0.08< td=""><td>2</td><td>Ignore</td><td></td></w≤0.08<>	2	Ignore	
	on polarizer		W>0.08	0		
4.2.2			n be seen after ng condition:	mobile p	hone in	
	Foroign	Siz	ze(mm)	Accept	able Qty	
	Foreign material	(longth)	\\//\\/idth\	Z	one	
	on	L(Length)	W(Width)	A B	С	Minor
	TP film	Ignore	W≤0.05	Ignore		
		L ≤5.0	0.05 <w≤0.08< td=""><td>3</td><td>Ignore</td><td></td></w≤0.08<>	3	Ignore	
			W>0.08	0		
	Dim line defect Polarizer	condition, j the scratch non-operat	er assembling or udge by the line can be seen on ing condition or e by the followin	defect o Ily in some sp	f 4.2.2. If	
		Size(mm) Acceptabl			able Qty	
4.2.3	scratch TP	L(Length)	W(Width)		one	Minor
	scratch			A B	C	-
		lgnore 5.0<	W≤0.03	Ignore	_	
		5.0< L≤10.0	0.03 <w≤0.05< td=""><td>2</td><td>Ignore</td><td></td></w≤0.05<>	2	Ignore	
		L≤5.0	0.05 <w≤0.08< td=""><td>1</td><td></td><td></td></w≤0.08<>	1		
			W>0.08	0		
		Air bubbles	s between glass	& polariz	zer	
		Zone		Acceptable Qty		
4.2.4	Polarize	Size(mm)	Size(mm)		C	Minor
7.2.7	Air bubble	Ф≤0.20		Ignore		
		0.20<Ф≤0.3	}	2	Ignore	
		Φ>0.30		0]	





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12 PRECAUTIONS FOR USE OF LCD MODULES

1. Handling Precautions

- (1) The display panel is made of glass and polarizer. As glass is fragile. It tends to become or chipped during handling especially on the edges. Please avoid dropping or jarring. Do not subject it to a mechanical shock by dropping it or impact.
- (2) If the display panel is damaged and the liquid crystal substance leaks out, be sure not to get any in your mouth. If the substance contacts your skin or clothes, wash it off using soap and water.
- (3) Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary. Do not touch the display with bare hands. This will stain the display area and degraded insulation between terminals (some cosmetics are determined to the polarizer).
- (4) The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully. Do not touch, push or rub the exposed polarizers with anything harder than an HB pencil lead (glass, tweezers, etc.). Do not put or attach anything on the display area to avoid leaving marks on. Condensation on the surface and contact with terminals due to cold will damage, stain or dirty the polarizer. After products are tested at low temperature they must be warmed up in a container before coming is contacting with room temperature air.
- (5) If the display surface becomes contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If it is heavily contaminated, moisten cloth with one of the following solvents
 - Isopropyl alcohol
 - Ethyl alcohol

Do not scrub hard to avoid damaging the display surface.

- (6) Solvents other than those above-mentioned may damage the polarizer. Especially, do not use the following.
 - Water
 - Ketone
 - Aromatic solvents

Wipe off saliva or water drops immediately, contact with water over a long period of time may cause deformation or color fading. Avoid contacting oil and fats.

- (7) Exercise care to minimize corrosion of the electrode. Corrosion of the electrodes is accelerated by water droplets, moisture condensation or a current flow in a high-humidity environment.
- (8) Install the LCD Module by using the mounting holes. When mounting the LCD module make sure it is free of twisting, warping and distortion. In particular, do not forcibly pull or bend the VO cable or the backlight cable.
- (9) Do not attempt to disassemble or process the LCD module.
- (10) NC terminal should be open. Do not connect anything.
- (11) If the logic circuit power is off, do not apply the input signals.

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(12) Electro-Static Discharge Control, Since this module uses a CMOS LSI, the same careful attention should be paid to electrostatic discharge as for an ordinary CMOS IC. To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.

- Before remove LCM from its packing case or incorporating it into a set, be sure the module and your body have the same electric potential. Be sure to ground the body when handling the LCD modules.

- Tools required for assembling, such as soldering irons, must be properly grounded. Make certain the AC power source for the soldering iron does not leak. When using an electric screwdriver to attach LCM, the screwdriver should be of ground potentiality to minimize as much as possible any transmission of electromagnetic waves produced sparks coming from the commutator of the motor.

- To reduce the amount of static electricity generated, do not conduct assembling and other work under dry conditions. To reduce the generation of static electricity be careful that the air in the work is not too dried. A relative humidity of 50%-60% is recommended. As far as possible make the electric potential of your work clothes and that of the work bench the ground potential

- The LCD module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated

- (13)Since LCM has been assembled and adjusted with a high degree of precision, avoid applying excessive shocks to the module or making any alterations or modifications to it.
 - Do not alter, modify or change the shape of the tab on the metal frame.
 - Do not make extra holes on the printed circuit board, modify its shape or change the positions of components to be attached.
 - Do not damage or modify the pattern writing on the printed circuit board.
 - Absolutely do not modify the zebra rubber strip (conductive rubber) or heat seal connector.
 - Except for soldering the interface, do not make any alterations or modifications with a soldering iron.
 Do not drop, bend or twist LCM.

2. Storage precautions

- 2.1 When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps.
- 2.2 The LCD modules should be stored under the storage temperature range. If the LCD modules will be stored for a long time, the recommend condition is:
 - Temperature : 0° C ~ 40° C Relatively humidity: $\leq 80\%$
- 2.3 The LCD modules should be stored in the room without acid, alkali and harmful gas.
- 2.4 The LCD modules should be no falling and violent shocking during transportation, and also should avoid excessive press, water, damp and sunshine.

----- END